



Z86C66

CMOS Z8®

16KROM MICROCONTROLLER

FEATURES

Part	ROM (KB)	RAM* (Bytes)	Speed (MHz)
Z86C66	16	256	16, 20

* General-Purpose

- n 44-Pin QFP Package
- n 3.0- to 5.5-Volt Operating Range
- n Low-Power Consumption
- n -40°C to +105°C Operating Range
- n Expanded Register File (ERF)
- n 32 Input/Output Lines

- n Vectored, Prioritized Interrupts with Programmable Polarity
- n Two Analog Comparators
- n Two Programmable 8-Bit Counter/Timers, Each with Two 6-Bit Programmable Prescaler
- n Watch-Dog Timer (WDT)/Power-On Reset (POR)
- n On-Chip Oscillator that Accepts a Crystal, Ceramic Resonator, LC, RC, or External Clock
- n RAM and ROM Protect

GENERAL DESCRIPTION

The Z86C66 microcontroller introduces a new level of sophistication to single-chip architecture. The Z86C66 is a member of the Z8 single-chip microcontroller family with 16 Kbytes of ROM and 256 bytes of RAM.

Zilog's CMOS microcontroller offers fast execution, more efficient use of memory, more sophisticated interrupts, input/output bit manipulation capabilities, and easy hardware/software system expansion along with low cost and low power consumption.

The Z86C66 architecture is characterized by Zilog's 8-bit microcontroller core. The device offers a flexible I/O scheme, an efficient register and address space structure, multiplexed capabilities between address/data, I/O, and a number of ancillary features that are useful in many industrial, advanced scientific, and **specifically high security applications**.

For applications which demand powerful I/O capabilities, the Z86C66 fulfills this with 32 pins dedicated to input and output. These lines are grouped into four ports with eight lines each. Each port is configurable under software control to provide timing, status signals, serial or parallel I/O with or without handshake, and an address/data bus for interfacing external memory.

There are three basic address spaces available to support this wide range of configurations: Program Memory, Data Memory, and 236 General-Purpose Registers.

To unburden the program from coping with the real-time problems such as counting/timing and serial data communication, the Z86C66 offers two on-chip counter/timers with a large number of user selectable modes, and an asynchronous receiver/transmitter (UART) (see Block Diagrams).

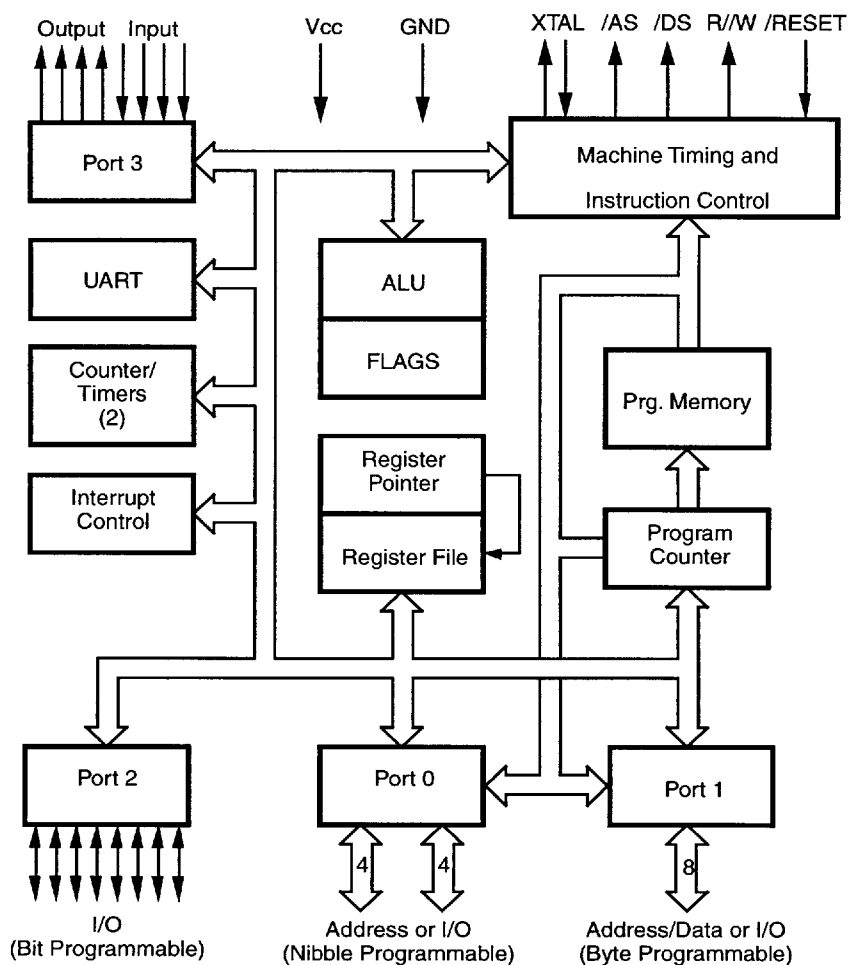
Notes:

All Signals with a preceding front slash, "/", are active Low, e.g., B/W (WORD is active Low); /B/W (BYTE is active Low, only).

Power connections follow conventional descriptions below:

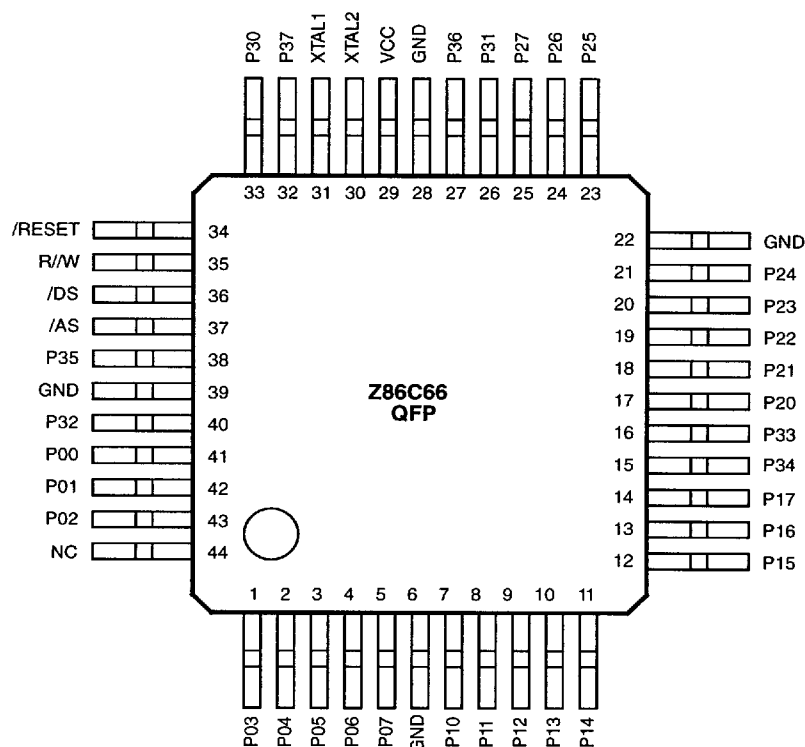
Connection	Circuit	Device
Power Ground	V _{CC} GND	V _{DD} V _{SS}

GENERAL DESCRIPTION



Z86C66 Functional Block Diagram

PIN DESCRIPTIONS



44-Lead QFP Pin Assignments

44-Lead QFP Pin Identification

Pin # tion	Symbol	Function	Direc- tion	Pin # tion	Symbol	Function	Direc- tion
1-5	P03-P07	Port 0 Pins 3,4,5,6,7	In/Output	31	XTAL1	Crystal, Oscillator Clock	Input
6	GND	Ground, GND	Input	32	P37	Port 3 Pin 7	Output
7-14	P10-P17	Port 1 Pins 0,1,2,3,4,5,6,7	In/Output	33	P30	Port 3 Pin 0	Input
15	P34	Port 3 Pin 4	Output	34	/RESET	Reset	Input
16	P33	Port 3 Pin 3	Input	35	R/W	Read/Write	Output
17-21	P20-P24	Port 2 Pins 0,1,2,3,4	In/Output	36	/DS	Data Strobe	Output
22	GND	Ground, GND	Input	37	/AS	Address Strobe	Output
23-25	P25-P27	Port 2 Pins 5,6,7	In/Output	38	P35	Port 3 Pin 5	Output
26	P31	Port 3 Pin 1	Input	39	GND	Ground, GND	Input
27	P36	Port 3 Pin 6	Output	40	P32	Port 3 Pin 2	Input
28	GND	Ground, GND	Input	41-43	P00-P02	Port 0 Pins 0,1,2	In/Output
29	V _{cc}	Power Supply	Input	44	NC	No Connect	
30	XTAL2	Crystal, Oscillator Clock	Output				

ABSOLUTE MAXIMUM RATINGS

Symbol	Description	Min	Max	Units
V_{CC}	Supply Voltage*	-0.3	+7.0	V
T_{STG}	Storage Temp	-65	+150	C
T_A	Oper Ambient Temp	†	†	

Notes:

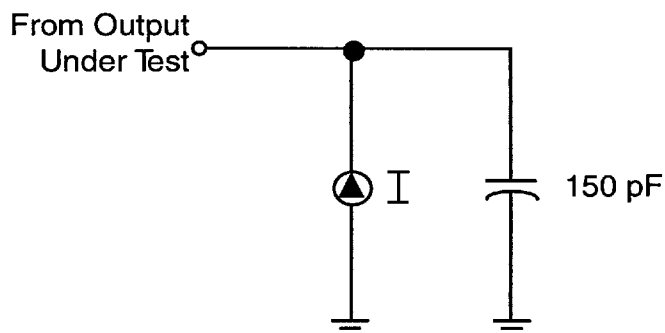
* Voltages on all pins with respect to GND.

† See ordering information

Stresses greater than those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; operation of the device at any condition above those indicated in the operational sections of these specifications is not implied. Exposure to absolute maximum rating conditions for an extended period may affect device reliability.

STANDARD TEST CONDITIONS

The characteristics listed below apply for standard test conditions as noted. All voltages are referenced to GND. Positive current flows into the referenced pin (Test Load).



Test Load Diagram

DC ELECTRICAL CHARACTERISTICS

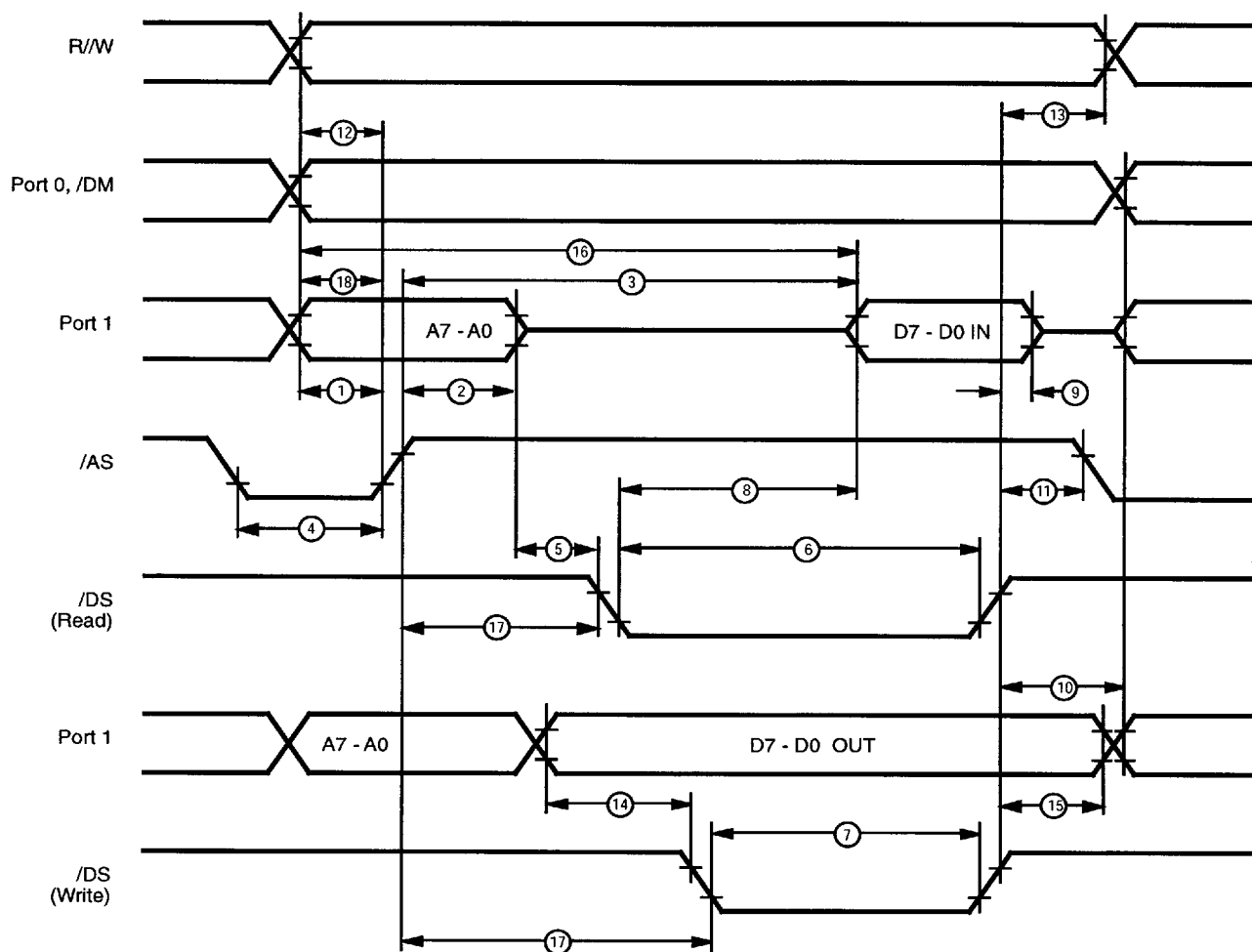
Z86C66

Sym	Parameter	$T_A = 0^\circ\text{C}$ to $+70^\circ\text{C}$		$T_A = -40^\circ\text{C}$ to $+105^\circ\text{C}$		Typical at 25°C	Units	Conditions
		Min	Max	Min	Max			
	Max Input Voltage		7		7		V	[4] $I_{IN} < 250\mu\text{A}$
V_{CH}	Clock Input High Voltage	$0.85V_{CC}$	$V_{CC} + 0.3$	$0.85V_{CC}$	$V_{CC} + 0.3$		V	Driven by External Clock Generator
V_{CL}	Clock Input Low Voltage	$V_{SS} - 0.3$	0.8	$V_{SS} - 0.3$	0.8		V	Driven by External Clock Generator
V_H	Input High Voltage	2	$V_{CC} + 0.3$	2	$V_{CC} + 0.3$		V	
V_L	Input Low Voltage	$V_{SS} - 0.3$	$0.2V_{CC}$	$V_{SS} - 0.3$	$0.2V_{CC}$		V	
V_{OH}	Output High Voltage	2.4		2.4			V	$I_{OH} = -2.0\text{mA}$
V_{OH}	Output High Voltage		$V_{CC} - 100\text{mV}$		$V_{CC} - 100\text{mV}$		V	$I_{OH} = -100\mu\text{A}$
V_{OH}	Output High Voltage (Low EMI)	2.4		2.4			V	$I_{OH} = -0.5\text{mA}$
V_{OL}	Output Low Voltage		0.4		0.4		V	$I_{OL} = +5.0\text{mA}$ [3]
V_{OL}	Output Low Voltage (Low EMI)		0.4		0.4		V	$I_{OL} = +2.0\text{mA}$ [3]
V_{OL}	Output Low Voltage		0.6		0.6		V	$I_{OL} = +4.0\text{mA}$ [2]
V_{OL}	Output Low Voltage (Low EMI)		0.6		0.6		V	$I_{OL} = +1.0\text{mA}$ [2]
V_{IH}	Reset Input High Voltage	$0.85V_{CC}$	$V_{CC} + 0.3$	$0.85V_{CC}$	$V_{CC} + 0.3$		V	
V_{IL}	Reset Input Low Voltage	-0.3	$0.2V_{CC}$	-0.3	$0.2V_{CC}$		V	
I_L	Input Leakage	-2	2	-2	2		μA	$V_{IN} = 0\text{V}, V_{CC}$
I_{OL}	Output Leakage	-2	2	-2	2		μA	$V_{IN} = 0\text{V}, V_{CC}$
I_R	Reset Input Current		-180		-180		μA	$V_{RL} = 0\text{V}$
I_{CC}	Supply Current (Standard Mode)		35		35	24	nA	[1] @ 16MHz
I_{CC}	Supply Current (Standard Mode)		40		40	30	nA	[1] @ 20MHz
I_{CC}	Supply Current (Low EMI)		6.0			4.0	nA	@ 4MHz
I_{CC1}	Standby Current (Standard Mode)		15		15	4.5	nA	[1] HALT Mode $V_{IN} = 0\text{V}, V_{CC}$ @ 16MHz
I_{CC1}	Standby Current (Low EMI)		1.6			0.8	nA	@ 4MHz
I_{CC2}	Standby Current		10		20	5	μA	[1] STOP Mode $V_{IN} = 0\text{V}, V_{CC}$
I_{ALL}	Auto Latch Low Current	-14	14	-20	20	5	μA	

Notes:

- [1] All inputs driven to either 0V or V_{CC} , outputs floating.
- [2] $V_{CC} = 3.0\text{V}$ to 3.6V
- [3] $V_{CC} = 4.5\text{V}$ to 5.5V
- [4] /Reset pin must be a maximum of $V_{CC} + 0.3\text{V}$.

AC CHARACTERISTICS



External I/O or Memory Read/Write

AC CHARACTERISTICS

External I/O or Memory Read and Write Timing
Z86C66 (16 MHz—Standard Mode Only[4])

No	Symbol	Parameter	T _A = 0°C to +70°C 16 MHz		T _A = -40°C to +105°C 16 MHz		Units	Notes
			Min	Max	Min	Max		
1	TdA(AS)	Address Valid to /AS rise Delay	25		25		ns	[2,3]
2	TdAS(A)	/AS rise to Address Float Delay	35		35		ns	[2,3]
3	TdAS(DR)	/AS rise to Read Data Req'd Valid		150		150	ns	[1,2,3]
4	TwAS	/AS Low Width	40		40		ns	[2,3]
5	TdAZ(DS)	Address Float to /DS fall	0		0		ns	
6	TwDSR	/DS (Read) Low Width		135		135	ns	[1,2,3]
7	TwDSW	/DS (Write) Low Width	80		80		ns	[1,2,3]
8	TdDSR(DR)	/DS fall to Read Data Req'd Valid	75		75		ns	[1,2,3]
9	ThDR(DS)	Read Data to /DS rise Hold Time	0		0		ns	[2,3]
10	TdDS(A)	/DS rise to Address Active Delay	50		50		ns	[2,3]
11	TdDS(AS)	/DS rise to /AS fall Delay	35		35		ns	[2,3]
12	TdR/W(AS)	R/W Valid to /AS rise Delay	25		25		ns	[2,3]
13	TdDS(R/W)	/DS rise to R/W Not Valid	35		35		ns	[2,3]
14	TdDW(DSW)	Write Data Valid to /DS fall (Write) Delay	25		25		ns	[2,3]
15	TdDS(DW)	/DS rise to Write Data Not Valid Delay	35		35		ns	[2,3]
16	TdA(DR)	Address Valid to Read Data Req'd Valid		210		210	ns	[1,2,3]
17	TdAS(DS)	/AS rise to /DS fall Delay	45		45		ns	[2,3]
18	TdDM(AS)	/DM Valid to /AS rise Delay	25		25		ns	[2,3]

Notes:

- [1] When using extended memory timing add 2 TpC.
- [2] Timing numbers given are for minimum TpC.
- [3] See clock cycle dependent characteristics table.
- [4] Low EMI is not selected.

Standard Test Load

All timing references use 2.0 V for a logic 1 and 0.8 V for a logic 0.

Clock Dependent Formulas

Number	Symbol	Equation
1	TdA(AS)	0.40 TpC + 0.32
2	TdAS(A)	0.59 TpC - 3.25
3	TdAS(DR)	2.83 TpC + 6.14
4	TwAS	0.66 TpC - 1.65
6	TwDSR	2.33 TpC - 10.56
7	TwDSW	1.27 TpC + 1.67
8	TdDSR(DR)	1.97 TpC - 42.5
10	TdDS(A)	0.8 TpC
11	TdDS(AS)	0.59 TpC - 3.14
12	TdR/W(AS)	0.4 TpC
13	TdDS(R/W)	0.8 TpC - 15
14	TdDW(DSW)	0.4 TpC
15	TdDS(DW)	0.88 TpC - 19
16	TdA(DR)	4 TpC - 20
17	TdAS(DS)	0.91 TpC - 10.7
18	TdDM(AS)	0.9 TpC - 26.3

AC CHARACTERISTICS

External I/O or Memory Read and Write Timing
Z86C66 (20 MHz—Standard Mode Only[4])

No	Symbol	Parameter	T _A = 0°C to +70°C 20 MHz		T _A = -40°C to +105°C 20 MHz		Units	Notes
			Min	Max	Min	Max		
1	TdA(AS)	Address Valid to /AS rise Delay	15		25		ns	[2,3]
2	TdAS(A)	/AS rise to Address Float Delay	25		35		ns	[2,3]
3	TdAS(DR)	/AS rise to Read Data Req'd Valid		120		120	ns	[1,2,3]
4	TwAS	/AS Low Width	30		30		ns	[2,3]
5	TdAZ(DS)	Address Float to /DS fall	0		0		ns	
6	TwDSR	/DS (Read) Low Width		105		105	ns	[1,2,3]
7	TwDSW	/DS (Write) Low Width	65		65		ns	[1,2,3]
8	TdDSR(DR)	/DS fall to Read Data Req'd Valid	55		55		ns	[1,2,3]
9	ThDR(DS)	Read Data to /DS rise Hold Time	0		0		ns	[2,3]
10	TdDS(A)	/DS rise to Address Active Delay	40		40		ns	[2,3]
11	TdDS(AS)	/DS rise to /AS fall Delay	25		25		ns	[2,3]
12	TdR/W(AS)	R/W Valid to /AS rise Delay	20		20		ns	[2,3]
13	TdDS(R/W)	/DS rise to R/W Not Valid	25		25		ns	[2,3]
14	TdDW(DSW)	Write Data Valid to /DS fall (Write) Delay	20		20		ns	[2,3]
15	TdDS(DW)	/DS rise to Write Data Not Valid Delay	25		25		ns	[2,3]
16	TdA(DR)	Address Valid to Read Data Req'd Valid		150		150	ns	[1,2,3]
17	TdAS(DS)	/AS rise to /DS fall Delay	35		35		ns	[2,3]
18	TdDM(AS)	/DM Valid to /AS rise Delay	15		15		ns	[2,3]

Notes:

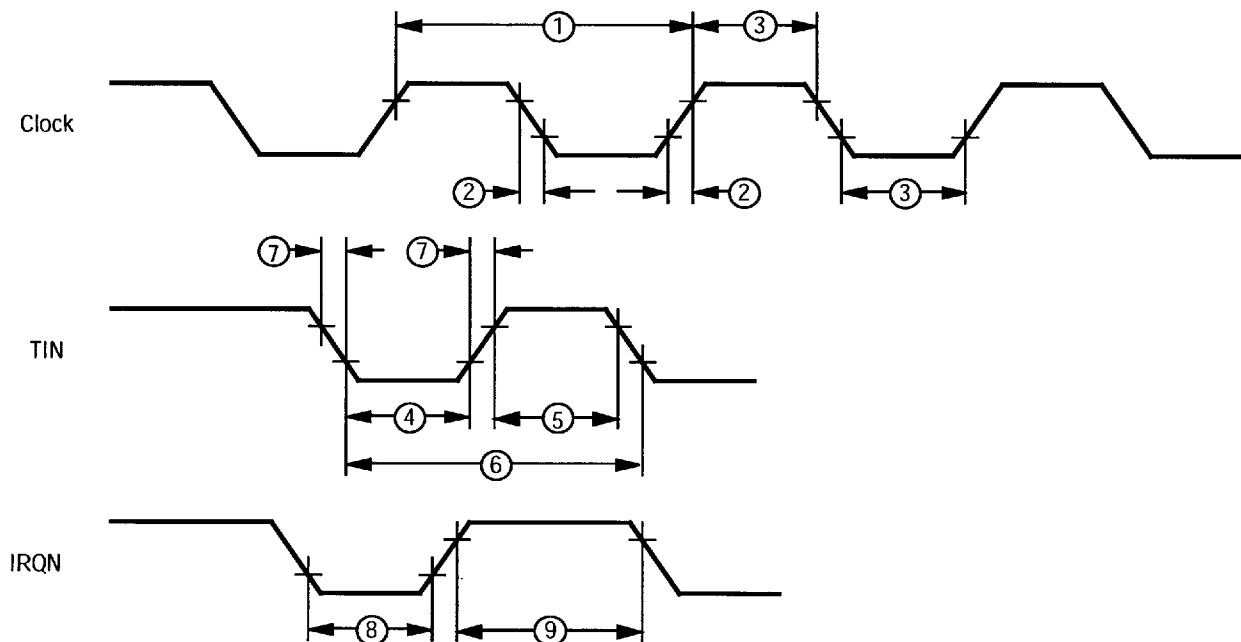
- [1] When using extended memory timing add 2 TpC.
- [2] Timing numbers given are for minimum TpC.
- [3] See clock cycle dependent characteristics table.
- [4] Low EMI is not selected.

Standard Test Load

All timing references use 2.0 V for a logic 1 and 0.8 V for a logic 0.

AC CHARACTERISTICS

Additional Timing Diagram



Additional Timing

AC CHARACTERISTICS

Additional Timing Table

Z86C66 (Standard Mode Only)

No	Symbol	Parameter	T _A = 0°C to +70°C 20/16 MHz		T _A = -40°C to +105°C 20/16 MHz		Units	Notes
			Min	Max	Min	Max		
1	TpC	Input Clock Period	50/62.5	1000	50/62.5	1000	ns	[1]
2	TrC,TfC	Clock Input Rise & Fall Times		10		10	ns	[1]
3	TwC	Input Clock Width	25/31		25/31		ns	[1]
4	TwTinL	Timer Input Low Width	75		75		ns	[2]
5	TwTinH	Timer Input High Width	5 TpC		5 TpC		ns	[2]
6	TpTin	Timer Input Period	8 TpC		8 TpC		ns	[2]
7	TrTin,TfTin	Timer Input Rise and Fall Times	100		100		ns	[2]
8 a	TwIL	Interrupt Request Input Low Times	70		50		ns	[2,4]
8 b	TwIL	Interrupt Request Input Low Times	5 TpC		5 TpC		ns	[2,5]
9	TwIH	Interrupt Request Input High Times	5 TpC		5 TpC		ns	[2,3]

Notes:

[1] Clock timing references use 0.85V_{CC} for a logic 1 and 0.8V for a logic 0.

[2] Timing references use 2.0V for a logic 1 and 0.8V for a logic 0.

[3] Interrupt references request through Port 3.

[4] Interrupt request through Port 3 (P33-P31).

[5] Interrupt request through Port 30.

AC CHARACTERISTICS

Additional Timing Table
Z86C66 (Low EMI Mode Only)

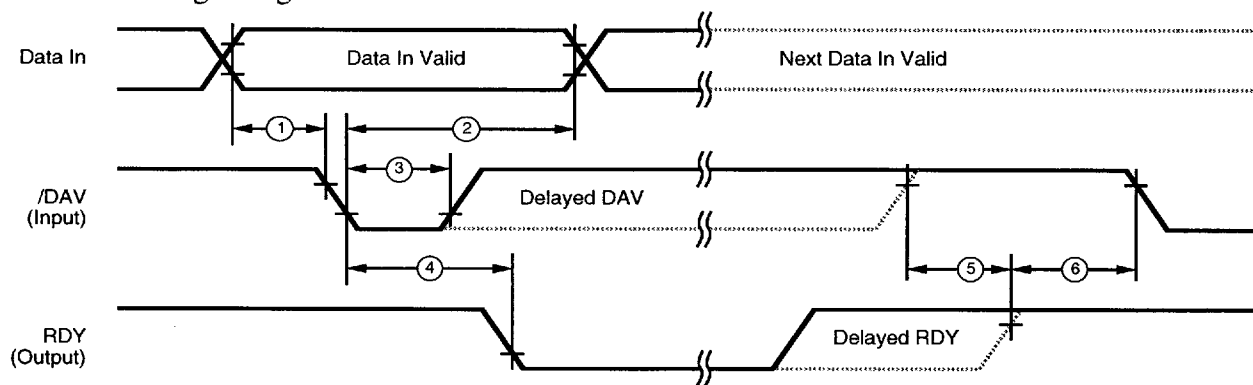
No	Symbol	Parameter	T _A = 0°C to +70°C 4 MHz		T _A = -40°C to +105°C 4 MHz		Units	Notes
			Min	Max	Min	Max		
1	TpC	Input Clock Period	250	DC	250	DC	ns	[1]
2	TrC,TfC	Clock Input Rise & Fall Times		10		10	ns	[1]
3	TwC	Input Clock Width	125		125		ns	[1]
4	TwTinL	Timer Input Low Width	75		75		ns	[2]
5	TwTinH	Timer Input High Width	3 TpC		3 TpC		ns	[2]
6	TpTin	Timer Input Period	4 TpC		4 TpC		ns	[2]
7	TrTin,TfTin	Timer Input Rise and Fall Times	100		100		ns	[2]
8 a	TwIL	Interrupt Request Input Low Times	70		50		ns	[2,4]
8 b	TwIL	Interrupt Request Input Low Times	3 TpC		3 TpC		ns	[2,5]
9	TwIH	Interrupt Request Input High Times	3 TpC		3 TpC		ns	[2,3]

Notes:

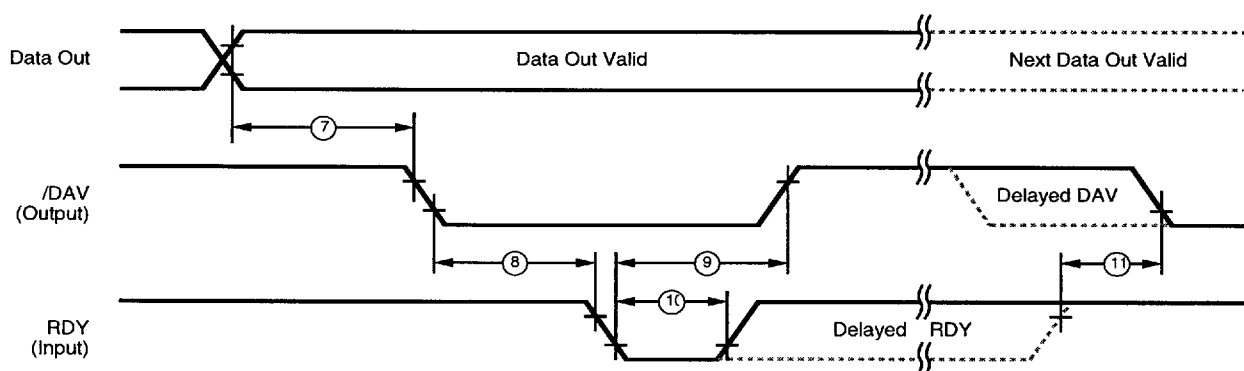
- [1] Clock timing references use 0.85V_{cc} for a logic 1 and 0.8V for a logic 0.
- [2] Timing references use 2.0V for a logic 1 and 0.8V for a logic 0.
- [3] Interrupt references request through Port 3.
- [4] Interrupt request through Port 3 (P33-P31).
- [5] Interrupt request through Port 30.

AC CHARACTERISTICS

Handshake Timing Diagrams



Input Handshake Timing



Output Handshake Timing

AC ELECTRICAL CHARACTERISTICS

Handshake Timing Table
Z86C66

No	Symbol	Parameter	$T_A = 0^{\circ}\text{C to } +70^{\circ}\text{C}$ 20/16 MHz		$T_A = -40^{\circ}\text{C to } +105^{\circ}\text{C}$ 20/16 MHz		Data Direction
			Min	Max	Min	Max	
1	TsDI(DAV)	Data In Setup Time	0		0		IN
2	ThDI(DAV)	Data In Hold Time	145		145		IN
3	TwDAV	Data Available Width	110		110		IN
4	TdDAVI(RDY)	DAV Fall to RDY Fall Delay	115		115		IN
5	TdDAVIId(RDY)	DAV Rise to RDY Rise Delay	115		115		IN
6	TdRDY0(DAV)	RDY Rise to DAV Fall Delay	0		0		IN
7	TdDO(DAV)	Data Out to DAV Fall Delay	TpC		TpC		OUT
8	TdDAV0(RDY)	DAV Fall to RDY Fall Delay	0		0		OUT
9	TdRDY0(DAV)	RDY Fall to DAV Rise Delay	115		115		OUT
10	TwRDY	RDY Width	110		110		OUT
11	TdRDY0d(DAV)	RDY Rise to DAV Fall Delay	115		115		OUT

Pre-Characterization Product:

The product represented by this CPS is newly introduced and Zilog has not completed the full characterization of the product. The CPS states what Zilog knows about this product at this time, but additional features or non-conformance with some aspects of the CPS may be found,

either by Zilog or its customers in the course of further application and characterization work. In addition, Zilog cautions that delivery may be uncertain at times, due to start-up yield issues.

Low Margin:

Customer is advised that this product does not meet Zilog's internal guardbanded test policies for the specification requested and is supplied on an exception basis. Customer is cautioned that delivery may be uncertain and that, in addition to all other limitations on Zilog liability

stated on the front and back of the acknowledgement, Zilog makes no claim as to quality and reliability under the CPS. The product remains subject to standard warranty for replacement due to defects in materials and workmanship.

© 1996 by Zilog, Inc. All rights reserved. No part of this document may be copied or reproduced in any form or by any means without the prior written consent of Zilog, Inc. The information in this document is subject to change without notice. Devices sold by Zilog, Inc. are covered by warranty and patent indemnification provisions appearing in Zilog, Inc. Terms and Conditions of Sale only. Zilog, Inc. makes no warranty, express, statutory, implied or by description, regarding the information set forth herein or regarding the freedom of the described devices from intellectual property infringement. Zilog, Inc. makes no warranty of merchantability or fitness for any purpose. Zilog, Inc. shall not be responsible for any errors that may appear in this document. Zilog, Inc. makes no commitment to update or keep current the information contained in this document.

Zilog's products are not authorized for use as critical components in life support devices or systems unless a specific written agreement pertaining to such intended use is executed between the customer and Zilog prior to use. Life support devices or systems are those which are intended for surgical implantation into the body, or which sustains life whose failure to perform, when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in significant injury to the user.

Zilog, Inc. 210 East Hacienda Ave.
Campbell, CA 95008-6600
Telephone (408) 370-8000
FAX 408 370-8056
Internet: <http://www.zilog.com>